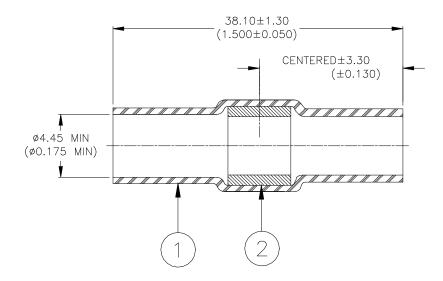
CUSTOMER DRAWING



MATERIALS

1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.

Recovered I.D.: 1.90 (0.075) max. 2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Sn63 per ANSI-J-STD-006. FLUX: TYPE ROM1 per ANSI-J-STD-004.

APPLICATION

1. This part is designed to make a non-sealed in-line splice in conductors.

Splice Criteria:

Conductor Type: Bare or Tin plated copper

Circular Mil Range: 3600 to 6000

Insulation Diameter: 1.90 to 4.50 (0.075 to 0.175)

- 2. Wires are to be stripped 19.0 to 25.40 (0.75 to 1.00) overlapped under the solder perform.
- 3. Part may be installed with Tyco Electronics/Raychem approved hot-air or infrared heaters.
- 4. Part will meet requirements of Tyco Electronics/Raychem Specification RT-1404.

ETE TE Connectivity				SOLDERSLEEVE WIRE SPLICE IN-LINE, NON SEALED		
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets] Devices TOLERANCES: ANGLES: N/A Tyco Electronics Corporation reserves the				DOCUMENT NO.:	D-110-0	181
0.00 N/A 0.0 N/A 0 N/A	ROUGHNESS IN MICRON	right to amend th	is drawing at any time. luate the suitability of the	REV:	DATE: April 4, 2011	
PREPARED BY: YNGUYEN			BER: CO-11-006942	SCALE: NTS	SIZE:	SHEET: 1 of 1

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